

**ACE1500B****P-Channel Enhancement Mode Field Effect Transistor**

Description

The ACE1500B is P-Channel enhancement mode power MOSFET which is produced with high cell density and DMOS trench technology .This device particularly suits low voltage applications, especially for battery powered circuits, the tiny and thin outline saves PCB consumption.

Features

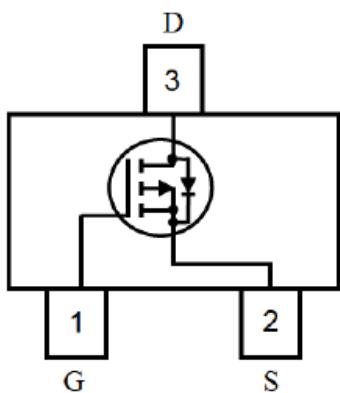
- $V_{DS}(V)=-20V$
- $I_D=-1.6A (V_{GS}=-4.5V)$
- $R_{DS(ON)} < 155m\Omega (V_{GS}=-4.5V)$
- $R_{DS(ON)} < 168m\Omega (V_{GS}=-2.5V)$
- $R_{DS(ON)} < 220m\Omega (V_{GS}=-1.8V)$

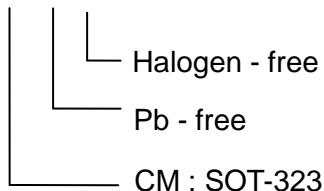
Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Drain-Source Voltage	V_{DSS}	-20	V
Gate-Source Voltage	V_{GSS}	± 12	V
Drain Current (Continuous) $T_A=25^\circ C$	I_D	-1.6	A
Drain Current (Pulse)	I_{DM}	-5	
Power Dissipation $T_A=25^\circ C$	P_D	350	mW
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Packaging Type

SOT-323



**ACE1500B****P-Channel Enhancement Mode Field Effect Transistor****Ordering information**ACE1500B XX + H**Electrical Characteristics** $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=-250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}$			-1	μA
Gate Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$			100	nA
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=-4.5\text{V}, I_D=-1\text{A}$		145	155	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_D=-0.5\text{A}$		150	168	
		$V_{\text{GS}}=-1.8\text{V}, I_D=-0.3\text{A}$		180	220	
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=-250\mu\text{A}$	-0.4	-0.7	-1	V
Forward Transconductance	g_{FS}	$V_{\text{DS}}=-5\text{V}, I_D=-2\text{A}$		5		S
Diode Forward Voltage	V_{SD}	$I_{\text{SD}}=-1.6\text{A}, V_{\text{GS}}=0\text{V}$		-0.93	-1.1	V
Maximum Body-Diode Continuous Current	I_S				-1.6	A
Switching						
Total Gate Charge	Q_g	$V_{\text{DS}}=-6\text{V}, I_D=-2.8\text{A}$ $V_{\text{GS}}=-4.5\text{V}$		4.9		nC
Gate-Source Charge	Q_{gs}			0.62		
Gate-Drain Charge	Q_{gd}			1.07		
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{DS}}=-6\text{V}, R_{\text{GEN}}=6\Omega,$ $V_{\text{GS}}=-4.5\text{V}$ $R_L=6\Omega$		10.1		ns
Turn-On Rise Time	t_f			4.76		
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			84.1		
Turn-Off Fall Time	t_f			25.2		
Dynamic						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-6\text{V}, V_{\text{GS}}=0\text{V}$ $f=1\text{MHz}$		472		pF
Output Capacitance	C_{oss}			71		
Reverse Transfer Capacitance	C_{rss}			51		

Notes:

1. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
2. Guaranteed by design, not subject to production testing.



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Typical Performance Characteristics

Fig.1 Output Characteristic

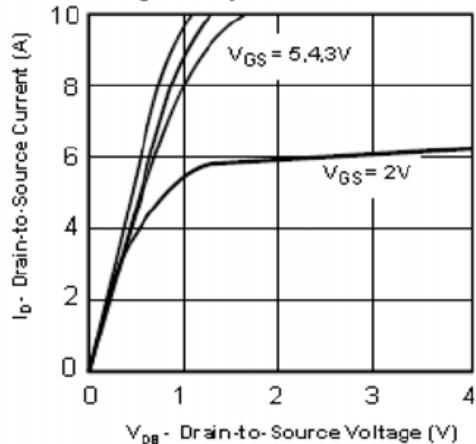


Fig.2 Transfer Characteristics

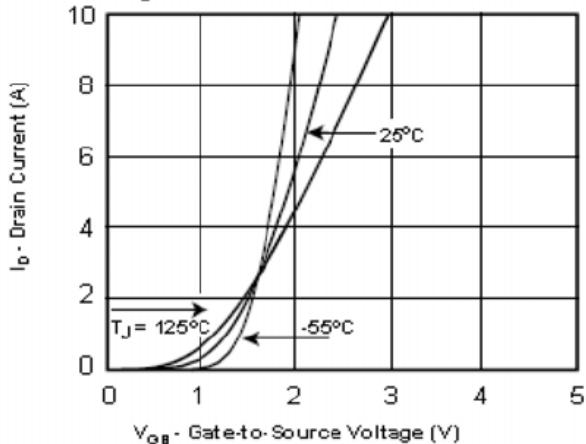


Fig.3 On-Resistance Variation with Temperature

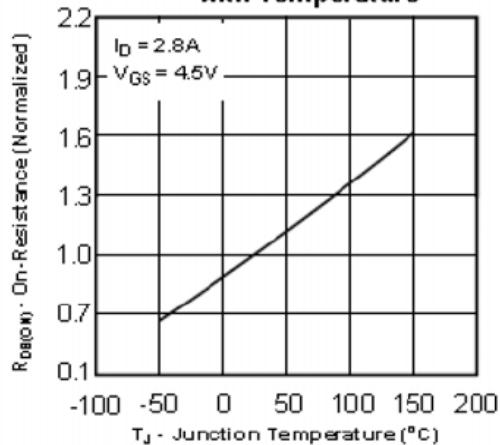


Fig.4 Body Diode Forward Voltage Variation with Source Current

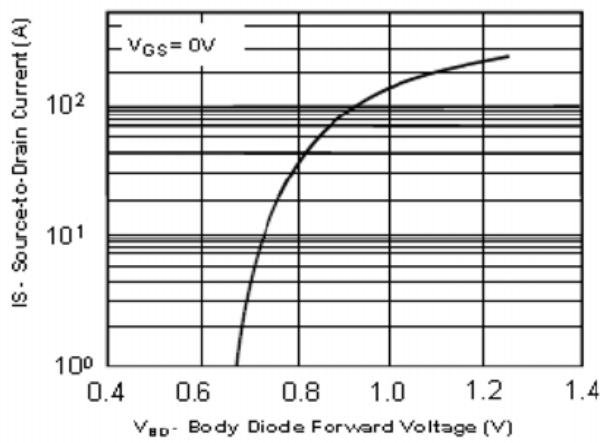


Fig.5 Gate Threshold Variation with Temperature

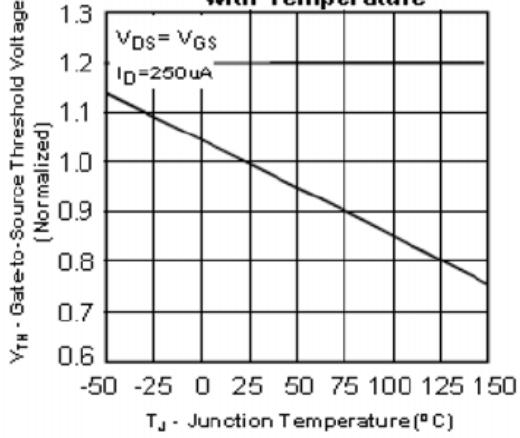
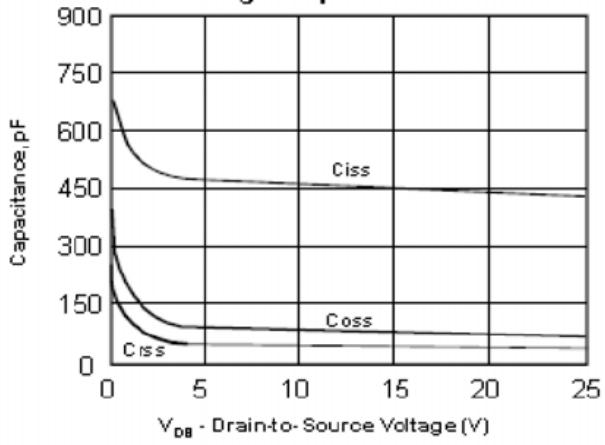


Fig.6 Capacitance





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Fig. 7 Gate Charge Waveform

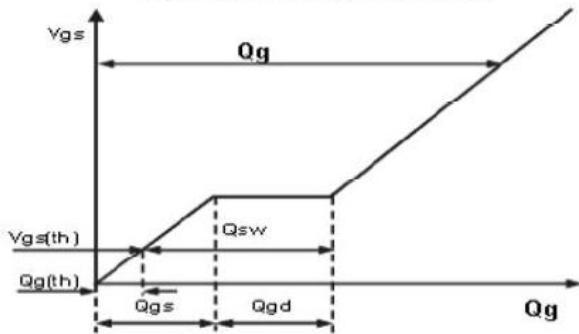


Fig. 8 Gate Charge

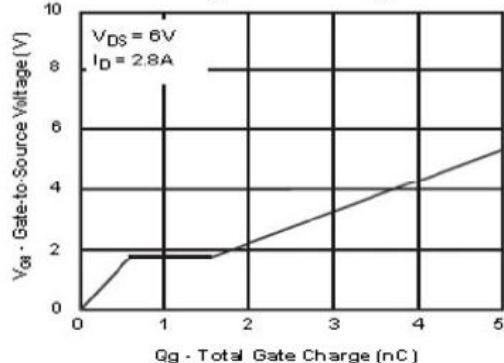


Fig. 9 Maximum Safe Operating Area

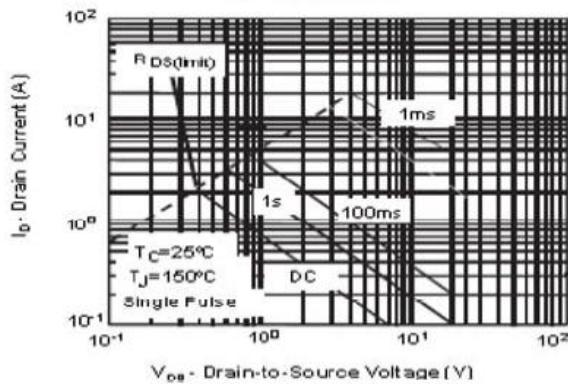
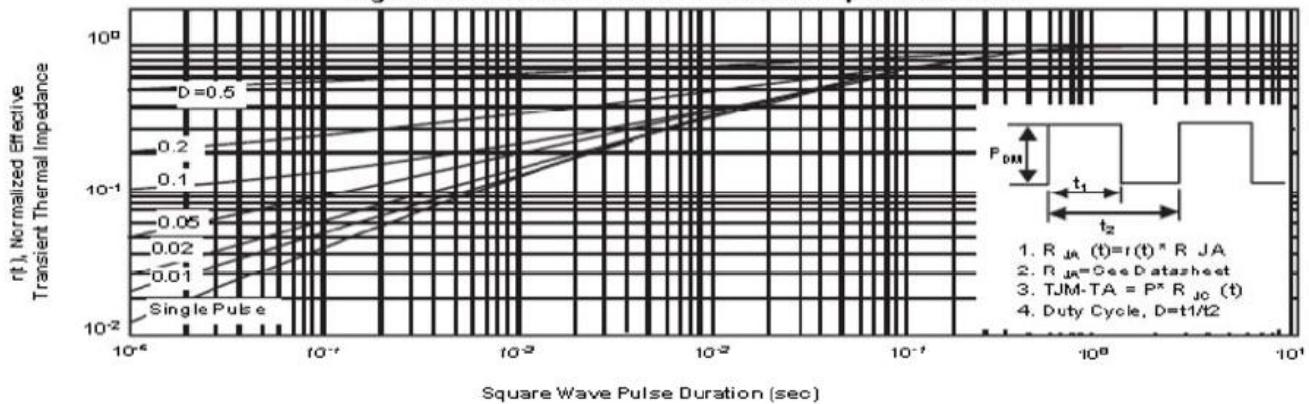


Fig. 10 Normalized Thermal Transient Impedance Curve



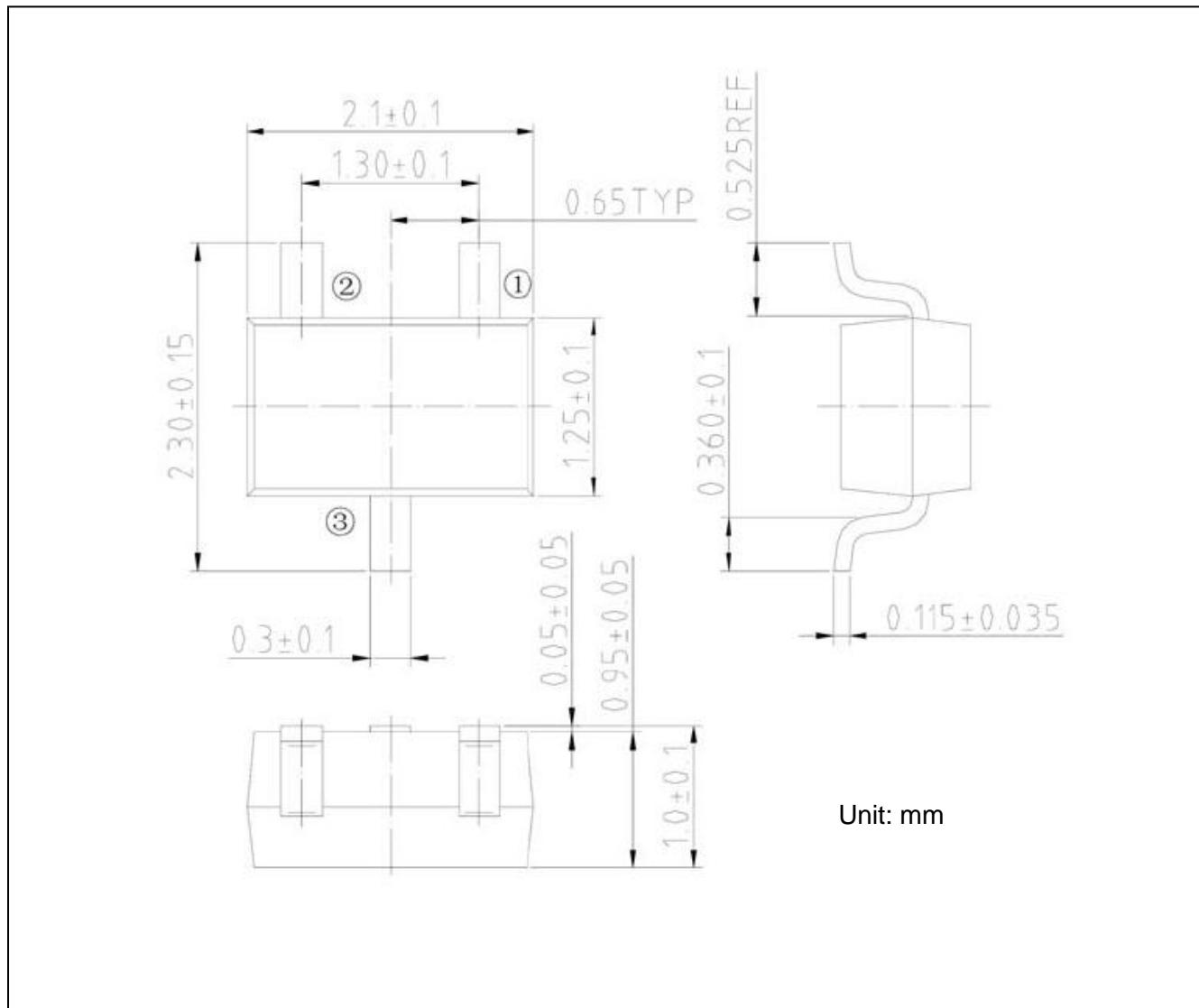


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Packing Information

SOT-323





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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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